```
s amorphous (5a) (Si or silicon) (p) laser# (p) (crystal? or recrystal?) (p)
(dangling bond# or spin(w)(state# or densit###))
         52139 AMORPHOUS
         65355 SI
        160670 SILICON
         97437 LASER#
        263468 CRYSTAL?
         71314 RECRYSTAL?
          2354 DANGLING
        170553 BOND#
           840 DANGLING BOND#
                 (DANGLING (W) BOND#)
         33083 SPIN
        792203 STATE#
        295327 DENSIT###
             3 AMORPHOUS (5A) (SI OR SILICON) (P) LASER# (P) (CRYSTAL? OR R
L1
ECR
               YSTAL?) (P) (DANGLING BOND# OR SPIN(W)(STATE# OR DENSIT###)
=> s laser# and (amorphous (5a)(Si or silicon)) (p) (crystal? or recrystal?)
(p) (dangling bond# or spin(w)(state# or densit###))
         97437 LASER#
         52139 AMORPHOUS
         65355 SI
        160670 SILICON
        263468 CRYSTAL?
         71314 RECRYSTAL?
          2354 DANGLING
        170553 BOND#
           840 DANGLING BOND#
                 (DANGLING (W) BOND#)
         33083 SPIN
        792203 STATE#
        295327 DENSIT###
           132 (AMORPHOUS (5A) (SI OR SILICON)) (P) (CRYSTAL? OR RECRYSTAL
?)
               (P) (DANGLING BOND# OR SPIN(W)(STATE# OR DENSIT###))
            42 LASER# AND (AMORPHOUS (5A)(SI OR SILICON)) (P) (CRYSTAL? O
L2
R R
               ECRYSTAL?) (P) (DANGLING BOND# OR SPIN(W) (STATE# OR DENSIT#
```

```
##)
```

=> s 12 and 437/173,174/cclst 571 437/173/CCLST 194 437/174/CCLST 717 437/173,174/CCLST

((437/173 OR 437/174)/CCLST)

L3 6 L2 AND 437/173,174/CCLST

=> s 13 not 11

L4 5 L3 NOT L1

 \Rightarrow s 12 and 427/clas or 437/clas

65684 427/CLAS

22065 437/CLAS

L5 22069 L2 AND 427/CLAS OR 437/CLAS

=> s (12 and(427/clas or 437/clas)) not (11 or 13) 65684 427/CLAS

22065 437/CLAS

L6 18 (L2 AND (427/CLAS OR 437/CLAS)) NOT (L1 OR L3)

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(Psy hereaften, an x 5; fin ... Kirlius to inprove the wide great hearts of durables in the 3. [5,352,291], Oct. 4, 1994, Method of annealing a semiconductor; Hongyong Zhang, et al., 117/8, 7 [IMAGE AVAILABLE] (BZy) The purpose (AN) XL X-S; By irrap william. - therefore many linear XL (BZy) the a Sic.

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[Magazian (Bio) (2) First- & Ph., the w/low (DI) As irral 4 wis by-annel by house to be a semiconductor device/circuit having at least partially crystallized semiconductor layer; Toru Takayama, et al., 437/21; 257/350; 437/41, 101, 953 [IMAGE AVAILABLE]

=> (A) A S A Laborate to bome abortical using by Catallot (Magazian) and the semiconductor layer to introduce the semiconductor and the semiconductor layer; Toru Takayama, et al., 437/21; 257/350; 437/41, 101, 953 [IMAGE AVAILABLE]

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